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INTEGRATED CIRCUITS

DATA SHEET

74ALVCHS16830

18-bit to 36-bit address driver with bus hold (3-State)

Product data Supersedes data of 2001 Sep 07





18-bit to 36-bit address driver with bus hold (3-State)

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FEATURES

- Diodes on inputs clamp overshoot
- ESD classification testing is done to JEDEC Standard JESD22.
 Protection exceeds 2000 V HBM per method A114.
- Latch-up testing is done to JEDEC Standard JESD78, which exceeds 100 mA.
- Bus hold on data inputs eliminates the need for external pullup/pulldown resistors
- Packaged in thin very small-outline package (TVSOP) 0.4 mm pitch
- Optimized for use with PCK953 in SDRAM module applications
- Low noise, low skew

DESCRIPTION

The ALVCHS16830 address driver is designed for 2.3 V to 3.6 V $\rm V_{CC}$ operation.

Diodes to V_{CC} have been added on the inputs to clamp overshoot.

The bus hold feature retains the inputs' last state whenever the input bus goes to high impedance. This prevents floating inputs and eliminates the need for pull up or pull down resistors.

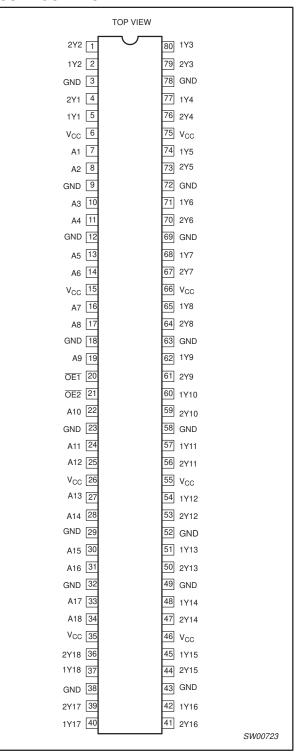
To ensure the high-impedance state during power up or power down, the output-enable (\overline{OE}) input should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The 74ALVCHS16830 is characterized for operation from -40 to $+85\,^{\circ}\text{C}$.

FUNCTION TABLE

	Inputs		Outp	uts
OE1	OE2	Α	1Yn	2Yn
L	Н	Н	Н	Z
L	Н	L	L	Z
Н	L	Н	Z	Н
Н	L	L	Z	L
L	L	Н	Н	Н
L	L	L	L	L
Н	Н	Х	Z	Z

PIN CONFIGURATION



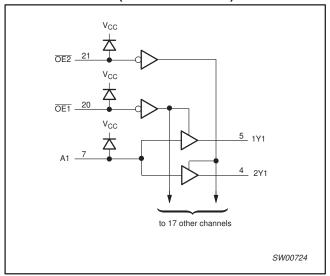
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DWG NUMBER
80-pin plastic thin very small outline (TVSOP)	–40 to +85 °C	74ALVCHS16830DGB	SOT647-1

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LOGIC DIAGRAM (POSITIVE LOGIC)



PIN DESCRIPTION

PIN(S)	SYMBOL	FUNCTION
6, 15, 26, 35, 46, 55, 66, 75	V _{CC}	Supply voltage
7, 8, 10, 11, 13, 14, 16, 17, 19, 22, 24, 25, 27, 28, 30, 31, 33, 34	An	Inputs
1, 2, 4, 5, 36, 37, 39, 40, 41, 42, 44, 45, 47, 48, 50, 51, 53, 54, 56, 57, 59, 60, 61, 62, 64, 65, 67, 68, 70, 71, 73, 74, 76, 77, 79, 80	1Yn, 2Yn	Outputs
20, 21	OE1, OE2	Output enable
3, 9, 12, 18, 23, 29, 32, 38, 43, 49, 52, 58, 63, 69, 72, 78	GND	Ground

ABSOLUTE MAXIMUM RATINGS

Over recommended operating free-air temperature range (unless otherwise noted).¹

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	Supply voltage range		-0.5 to +4.6	٧
VI	Input voltage range	See Note 2	-0.5 to +4.6	V
V _O	Output voltage range	See Notes 2 and 3	-0.5 to V _{CC} +0.5	V
I _{IK}	Input clamp current	V ₁ < 0	-50	mA
I _{OK}	Output clamp current	V _O < 0	– 50	mA
I _O	Continuous output current		±50	mA
I _{CC} , I _{GND}	Continuous current through each V _{CC} or GND		± 100	mA
$\Theta_{\sf JA}$	Package thermal impedance	See Note 4	106	°C/W
T _{stg}	Storage temperature range		−65 to +150	°C

NOTES:

- Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings
 only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating
 conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- 2. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
- 3. This value is limited to 4.6 V maximum.
- 4. The package thermal impedance is calculated in accordance with JESD 51.

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RECOMMENDED OPERATING CONDITIONS

All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

OVMDOL	DADAMETED	CONDITIONS	LIM	IITS	UNIT	
SYMBOL	PARAMETER	CONDITIONS	MIN	MAX]	
V _{CC}	Supply voltage		2.3	3.6	V	
V	High level input voltage	V _{CC} = 2.3 V to 2.7 V	1.7	_	V	
V _{IH}	High-level input voltage	V _{CC} = 2.7 V to 3.6 V	2	_	V	
V	l and level involved to a	V _{CC} = 2.3 V to 2.7 V	_	0.7	V	
V _{IL}	Low-level input voltage	Low-level input voltage V _{CC} = 2.7 V to 3.6 V		0.8	ľ	
VI	Input voltage		0	V _{CC}	V	
Vo	Output voltage			V _{CC}	V	
		V _{CC} = 2.3 V	_	-12		
I _{OH}	High-level output current	V _{CC} = 2.7 V	_	-12	mA	
		V _{CC} = 3 V	_	-24		
		V _{CC} = 2.3 V	_	12		
l _{OL}	Low-level output current	V _{CC} = 2.7 V	_	12	mA	
		V _{CC} = 3 V	— 24		1	
Δt/Δν	Input transition rise or fall rate		_	10	ns/V	
T _{amb}	Operating free-air temperature		-40	+85	°C	

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ELECTRICAL CHARACTERISTICS

Over recommended operating free-air temperature range (unless otherwise noted).

SYMBOL	PARAMETER	TEST CONDITIONS	V _{CC}	MIN	TYP ¹	MAX	UNIT
		I _I = -18 mA	2.3 V	_	_	-1.2	V
V_{IK}		I _I = 18 mA	2.3 V	_	_	V _{CC} +1.2	1 °
		I _{OH} = -100 μA	2.3 V to 3.6 V	V _{CC} -0.2	_	_	
		$I_{OH} = -4 \text{ mA}, V_{IH} = 1.7 \text{ V}$	2.3 V	1.9	_	_	\ \
V _{OH}		$I_{OH} = -6 \text{ mA}, V_{IH} = 1.7 \text{ V}$	2.3 V	1.7	_	_	
		$I_{OH} = -8 \text{ mA}, V_{IH} = 2 \text{ V}$	2.7 V	2.4	_	_	٧
	$I_{OH} = -12 \text{ mA}, V_{IH} = 2 \text{ V}$	3 V	2	_	_	`,,	
		$I_{OH} = -24 \text{ mA}, V_{IH} = 2 \text{ V}$	3 V	2	_	<u> </u>	٧
		Ι _{ΟL} = 100 μΑ	2.3 V to 3.6 V	_	_	0.2	
V _{OL}	I _{OL} = 4 mA, V _{IL} = 0.7 V	2.3 V	_	_	0.4	· ·	
		I _{OL} = 6 mA, V _{IL} = 0.7 V	2.3 V	_	_	0.55	
		I _{OL} = 8 mA, V _{IL} = 0.8 V	2.7 V	_	_	0.55	٧
		I _{OL} = 12 mA, V _{IL} = 0.8 V	3 V	_	_	0.6	,,
		I _{OL} = 24 mA, V _{IL} = 0.8 V	3 V	_	_	0.8	٧
I _I		V _I = V _{CC} or GND	3.6 V	_	_	±5	μΑ
		V _I = 0.7 V	2.3 V	45	_	_	
		V _I = 1.7 V	2.3 V	-4 5	_	_	
I _{I(hold)}		V _I = 0.8 V	3 V	75	_	_	μΑ
		V _I = 2 V	3 V	- 75	_	_	
		$V_1 = 0 \text{ to } 3.8 \text{ V}^2$	3.6 V	_	_	±500	
I _{OZ}		V _O = V _{CC} or GND	3.6 V	_	_	±10	μΑ
I _{CC}		$V_I = V_{CC}$ or GND, $I_O = 0$	3.6 V	_	_	40	μΑ
ΔI_{CC}		One input at $V_{CC} - 0.8 \text{ V}$, Other inputs at V_{CC} or GND	3 V to 3.6 V	_	_	750	μΑ
C	Control inputs	V _I = V _{CC} or GND	3.3 V	_	3.62	_	nE
C _i	Data inputs	AL = ACC OL GIAD	3.3 V	_	8.21	_	pF
Co	Outputs	V _O = V _{CC} or GND	3.3 V	_	3.53	_	pF

All typical values are at V_{CC} = 3.3 V, T_{amb} = 25 °C.
 This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

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SWITCHING CHARACTERISTICS

Over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 and 2).

PARAMETER	FROM	то	V _{CC} = 2.5	$V \pm 0.2 V$	V _{CC} =	2.7 V	V _{CC} = 3.3	$V \pm 0.3 V$	UNIT
FANAMETER	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	0.411
t _{pd}	Α	Υ	1.2	3.8	_	4	1.7	3.5	ns
t _{en}	ŌĒ	Υ	1	5.7	_	5.7	1	4.8	ns
t _{dis}	ŌĒ	Υ	1	4.9	_	5.4	1.7	5.2	ns
t _{sk(o)} 1	Output skew	_	_	_	_	_	_	500	ps

NOTE:

OPERATING CHARACTERISTICS, T_{amb} = 25 °C

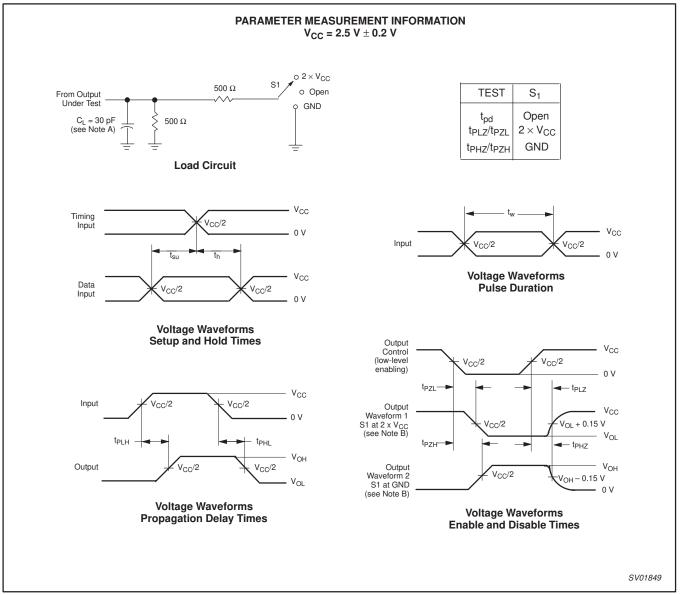
SYMBOL PARAMETER		PARAMETER TEST CONDITIONS		V_{CC} = 2.5 V \pm 0.2 V	$V \pm 0.2 \text{ V}$ $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		
O I WIDOL	1 4114	WILTER	TEST SONDITIONS	TYP	TYP	UNIT	
	Power dissipation	All outputs enabled	C ₁ = 0. f = 10 MHz	49	53	pF	
C _{pd}	capacitance per driver	الممالما منام مناسب مناسب مناسب الممالم		6	7.5	þΓ	

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^{1.} Output skew between any 2 outputs of same part switching in the same direction.

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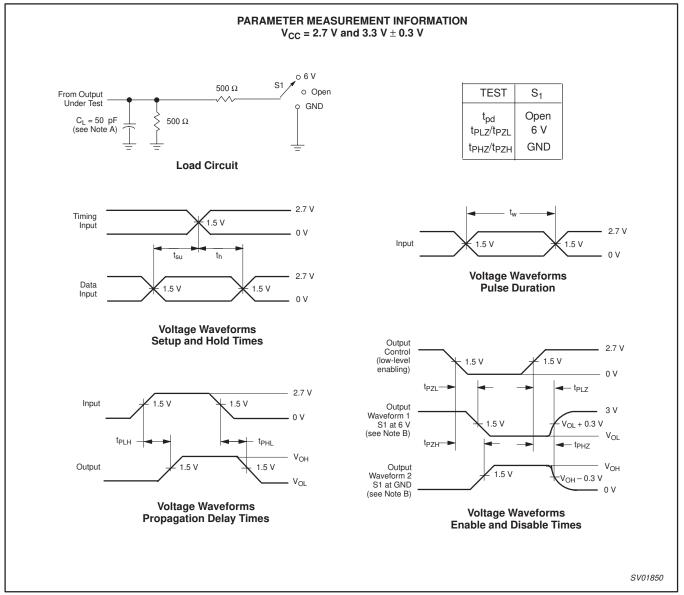
NOTES:

- A. C_L includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50~\Omega$, $t_f \leq$ 2 ns. $t_f \leq$ 2 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load circuit and voltage waveforms

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NOTES:

- A. C_L includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50~\Omega$, $t_f \leq$ 2.5 ns. $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd}.

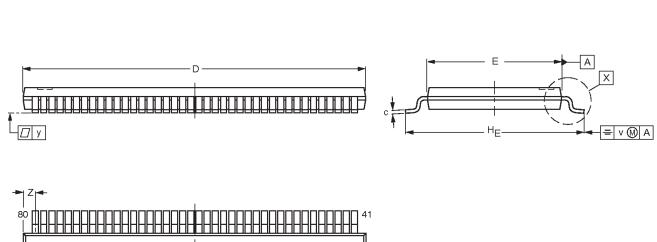
Figure 2. Load circuit and voltage waveforms

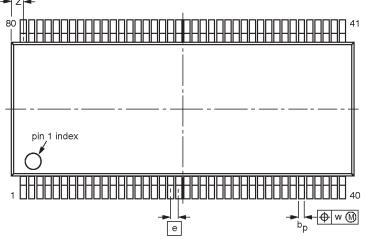
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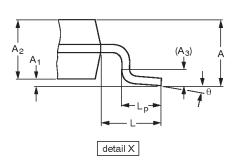
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TSSOP80: plastic thin shrink small outline package; 80 leads; body width 6.1 mm

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0 2.5 5 mm scale

DIMENSIONS (mm are the original dimensions).

UN	IIT	A max.	Α1	A ₂	А3	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	٧	w	у	z	θ
m	m	1.2	0.15 0.05	1.05 0.85	0.25	0.23 0.13	0.2 0.1	17.1 16.9	6.2 6.0	0.4	8.3 7.9	1.0	0.75 0.45	0.2	0.07	0.08	0.84 0.57	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT647-1		MO-153				00-08-21

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Data sheet status

Data sheet status ^[1]	Product status ^[2]	Definitions
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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^[1] Please consult the most recently issued data sheet before initiating or completing a design.

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Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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